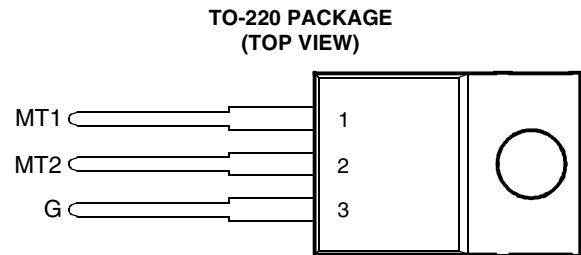


- Sensitive Gate Triacs
- 4 A RMS
- Glass Passivated Wafer
- 400 V to 700 V Off-State Voltage
- Max  $I_{GT}$  of 5 mA (Quadrants 1 - 3)



Pin 2 is in electrical contact with the mounting base.

MDC2ACA

**absolute maximum ratings over operating case temperature (unless otherwise noted)**

RATING		SYMBOL	VALUE	UNIT
Repetitive peak off-state voltage (see Note 1)	TIC206D	$V_{DRM}$	400	V
	TIC206M		600	
	TIC206S		700	
Full-cycle RMS on-state current at (or below) 85°C case temperature (see Note 2)		$I_T(RMS)$	4	A
Peak on-state surge current full-sine-wave at (or below) 25°C case temperature (see Note 3)		$I_{TSM}$	25	A
Peak gate current		$I_{GM}$	±0.2	A
Peak gate power dissipation at (or below) 85°C case temperature (pulse width ≤ 200 μs)		$P_{GM}$	1.3	W
Average gate power dissipation at (or below) 85°C case temperature (see Note 4)		$P_{G(AV)}$	0.3	W
Operating case temperature range		$T_C$	-40 to +110	°C
Storage temperature range		$T_{stg}$	-40 to +125	°C
Lead temperature 1.6 mm from case for 10 seconds		$T_L$	230	°C

- NOTES: 1. These values apply bidirectionally for any value of resistance between the gate and Main Terminal 1.  
 2. This value applies for 50-Hz full-sine-wave operation with resistive load. Above 85°C derate linearly to 110°C case temperature at the rate of 160 mA/°C.  
 3. This value applies for one 50-Hz full-sine-wave when the device is operating at (or below) the rated value of on-state current. Surge may be repeated after the device has returned to original thermal equilibrium. During the surge, gate control may be lost.  
 4. This value applies for a maximum averaging time of 20 ms.

**electrical characteristics at 25°C case temperature (unless otherwise noted)**

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$I_{DRM}$ Repetitive peak off-state current	$V_D = \text{rated } V_{DRM}$	$I_G = 0$	$T_C = 110^\circ\text{C}$			±1	mA
$I_{GT}$ Gate trigger current	$V_{supply} = +12 \text{ V} \dagger$	$R_L = 10 \Omega$	$t_{p(g)} > 20 \mu\text{s}$		0.9	5	mA
	$V_{supply} = +12 \text{ V} \dagger$	$R_L = 10 \Omega$	$t_{p(g)} > 20 \mu\text{s}$		-2.2	-5	
	$V_{supply} = -12 \text{ V} \dagger$	$R_L = 10 \Omega$	$t_{p(g)} > 20 \mu\text{s}$		-1.8	-5	
	$V_{supply} = -12 \text{ V} \dagger$	$R_L = 10 \Omega$	$t_{p(g)} > 20 \mu\text{s}$		2.4	10	

† All voltages are with respect to Main Terminal 1.

**PRODUCT INFORMATION**

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**electrical characteristics at 25°C case temperature (unless otherwise noted) (continued)**

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
V <sub>GT</sub>	Gate trigger voltage	V <sub>supply</sub> = +12 V†	R <sub>L</sub> = 10 Ω	t <sub>p(g)</sub> > 20 μs		0.7	2	V
		V <sub>supply</sub> = +12 V†	R <sub>L</sub> = 10 Ω	t <sub>p(g)</sub> > 20 μs		-0.7	-2	
		V <sub>supply</sub> = -12 V†	R <sub>L</sub> = 10 Ω	t <sub>p(g)</sub> > 20 μs		-0.7	-2	
		V <sub>supply</sub> = -12 V†	R <sub>L</sub> = 10 Ω	t <sub>p(g)</sub> > 20 μs		0.7	2	
V <sub>T</sub>	On-state voltage	I <sub>T</sub> = ±4.2 A	I <sub>G</sub> = 50 mA	(see Note 5)		±1.4	±2.2	V
I <sub>H</sub>	Holding current	V <sub>supply</sub> = +12 V†	I <sub>G</sub> = 0	Init' I <sub>TM</sub> = 100 mA		1.5	15	mA
		V <sub>supply</sub> = -12 V†	I <sub>G</sub> = 0	Init' I <sub>TM</sub> = -100 mA		-1.3	-15	
I <sub>L</sub>	Latching current	V <sub>supply</sub> = +12 V† V <sub>supply</sub> = -12 V†	(see Note 6)				30 -30	mA
dv/dt	Critical rate of rise of off-state voltage	V <sub>DRM</sub> = Rated V <sub>DRM</sub>	I <sub>G</sub> = 0	T <sub>C</sub> = 110°C		±20		V/μs
dv/dt <sub>(c)</sub>	Critical rise of commutation voltage	V <sub>DRM</sub> = Rated V <sub>DRM</sub>	I <sub>TRM</sub> = ±4.2 A	T <sub>C</sub> = 85°C	±1	±3		V/μs

† All voltages are with respect to Main Terminal 1.

NOTES: 5. This parameter must be measured using pulse techniques, t<sub>p</sub> = ≤ 1 ms, duty cycle ≤ 2 %. Voltage-sensing contacts separate from the current carrying contacts are located within 3.2 mm from the device body.

6. The triacs are triggered by a 15-V (open circuit amplitude) pulse supplied by a generator with the following characteristics: R<sub>G</sub> = 100 Ω, t<sub>p(g)</sub> = 20 μs, t<sub>r</sub> = ≤ 15 ns, f = 1 kHz.

**thermal characteristics**

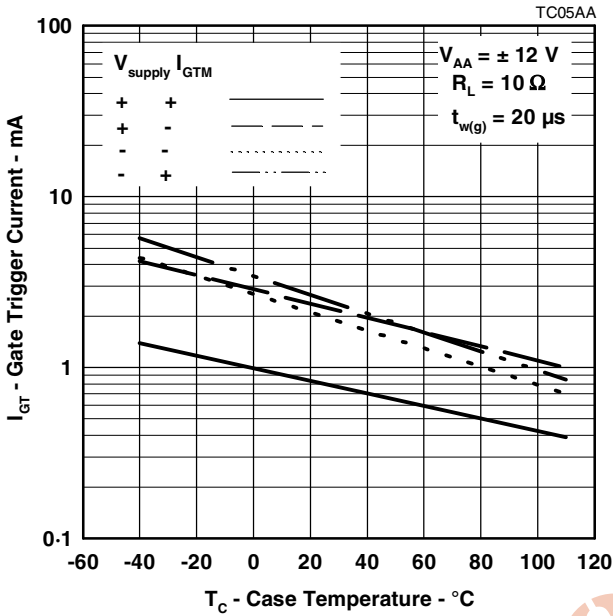
PARAMETER		MIN	TYP	MAX	UNIT
R <sub>θJC</sub>	Junction to case thermal resistance			7.8	°C/W
R <sub>θJA</sub>	Junction to free air thermal resistance			62.5	°C/W

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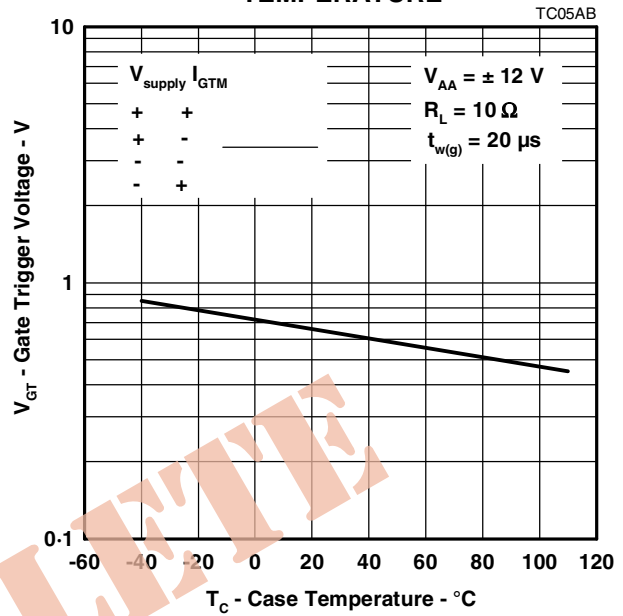
**TYPICAL CHARACTERISTICS**

**GATE TRIGGER CURRENT  
vs  
TEMPERATURE**



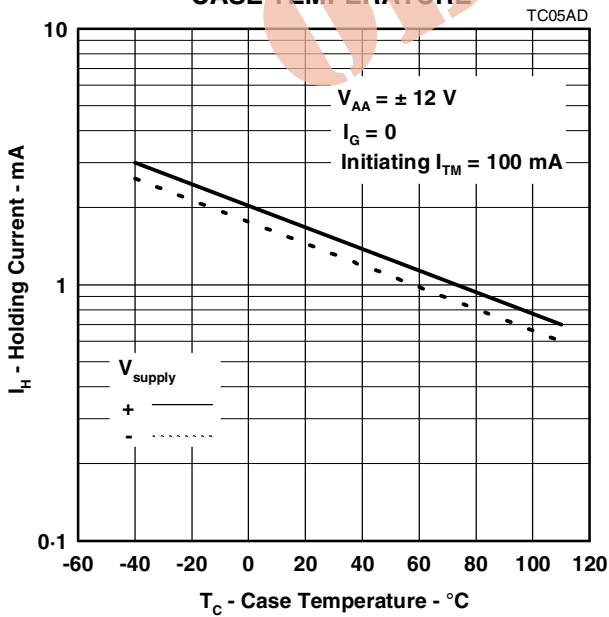
**Figure 1.**

**GATE TRIGGER VOLTAGE  
vs  
TEMPERATURE**



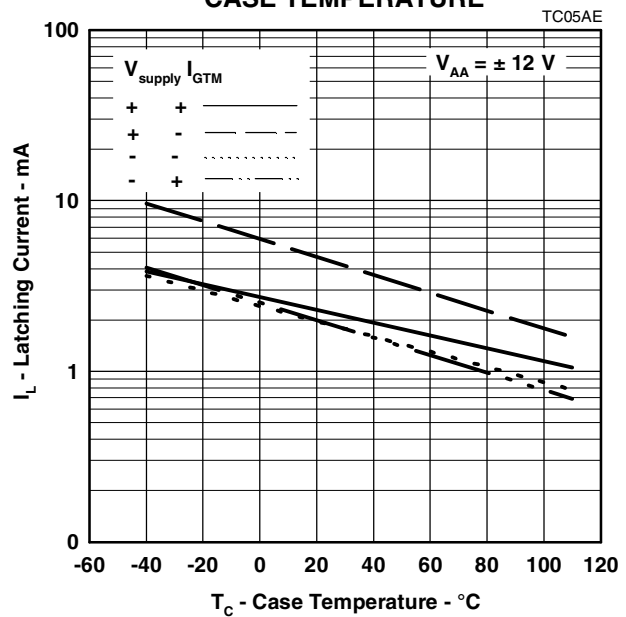
**Figure 2.**

**HOLDING CURRENT  
vs  
CASE TEMPERATURE**



**Figure 3.**

**LATCHING CURRENT  
vs  
CASE TEMPERATURE**



**Figure 4.**

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